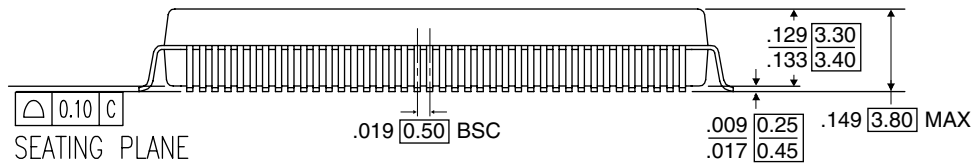
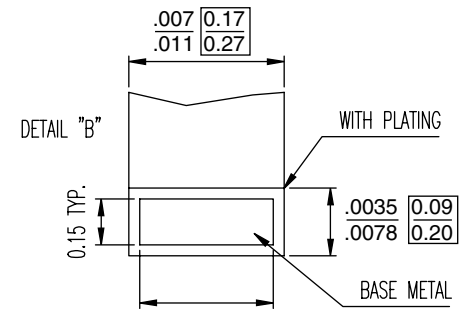
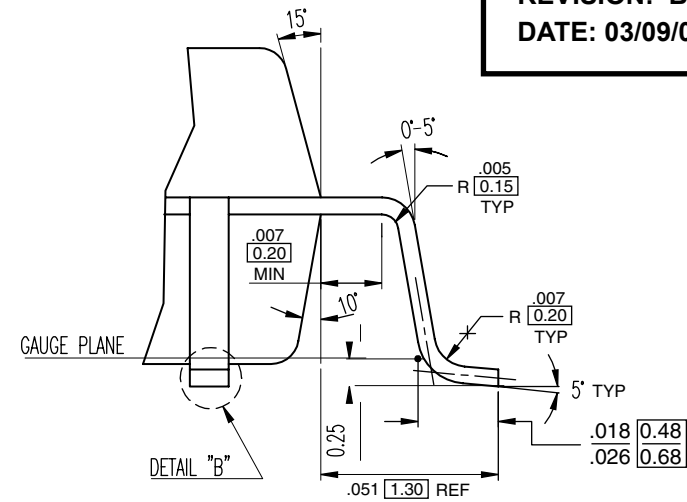
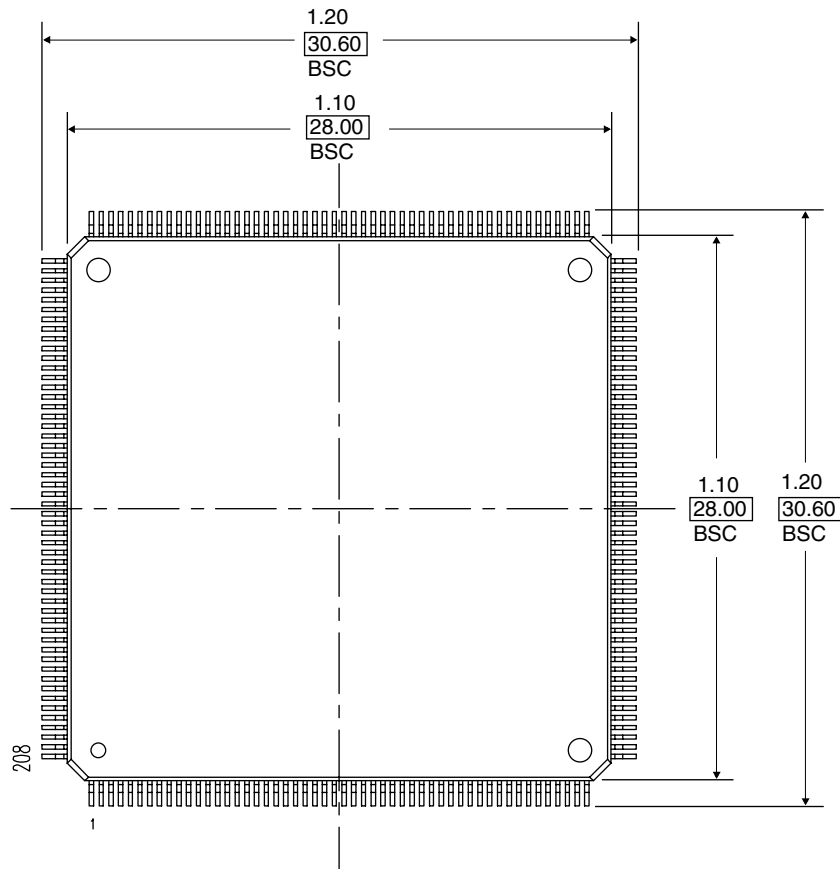


DOCUMENT CONTROL NO.
PD - 2012

REVISION: B
DATE: 03/09/05



- Note:**
1. Package Outline Exclusive of Mold Flash and Metal Burr
 2. Controlling dimensions in millimeters
 3. Ref: JEDEC MS-029A



Pericom Semiconductor Corporation
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DESCRIPTION: 208-Pin, Fine Pitch Metric Quad Flat Package, FQFP

PACKAGE CODE: MA